## **Tyrone Camarero Specifications**

# **Tyrone**

### Camarero: MDI300E1MG-420

#### **Key Feature**

- 4U (NVIDIA MGX™ Architecture)
- Dual Intel Xeon 6700E/6500P/6700P series Processors
- 8 x NVIDIA H200 NVL or RTX PRO 6000 Blackwell Server Edition PCle GPU cards
- Supports 16+16 DDR5 RDIMM Expandable Memory
- 13 x16 PCle 5.0 Expansion Slots
- Latest Aspeed AST2600 BMC Controller
- Support 20 x E1.S PCle 5.0 x4 NVMe Hot Swappable Bays
- 80+ Titanium CRPS Power Supply
- Enhanced Security with TPM 2.0, ROT and Chassis Intrusion
- Dual BIOS and Dual BMC





#### Processor/Cache

Processor

Dual Intel Xeon 6700E/6500P/6700P series Processors of TDP Upto 350W

(FCLGA 4710 E2)

#### System Memory

Memory Capacity Supports 16+16 DDR5 Expandable

Memory,

Max Frequency:

RDIMM : 6400MHz(1DPC), 5200MT/s(2DPC), MRDIMM : 8000MT/s(1DPC Only)

Max. Capacity per DIMM:

256GB(RDIMM), 64GB(MRDIMM),

Upto 8TB Memory

#### **Expansion Slot**

**PCI-Express** 

8 x16 PCle5.0 FHFL (Double Width) 5 x16 PCle5.0 FHFL (Single Width)

#### Drive bays

**HDD** Bays

20 x E1.s PCle 5.0 x4 NVMe Hot Swappable

Drives

2 x 2280/22110 M.2 PCle 5.0 x2 Fix Drives NVMe RAID 0/1/5/10 support with VROC

Key

#### Ports

**Ports** 

1 x 1000Base-T Dedicated Server Management Port (Rear)

2 x 10GBase-T Ethernet ports with Intel®

X710-AT2 (Rear)

1 x USB 3.0 Type-A Port (Rear) 1 x Mini Display port (Rear)

#### Indicators

Indicators

1 x Power LED Button (Rear) 1 x UID LED Button (Rear)

#### Security

Security

Chassis Intrusion TPM 2.0 ROT (Optional)

#### **Power Supply**

**Power Supply** 

3200W (3+1) 80+ CRPS Titanium

Certified

#### Environment

**Temperature** 

System Operating Temperature:

0°C ~ 35°C

Non-operating Temperature: -20°C

~ 70°C'

Humidity

Non-operating Relative Humidity: 5% to 85% (non-condensing)

#### Form Factor

Form Factor

4U Rackmount

#### **Dimensions**

Dimensions

438mm(W) x 175mm(H) x 800mm(D)

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www.tyronesystems.com

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